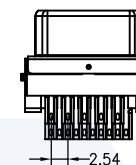
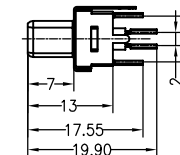
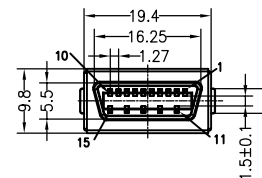
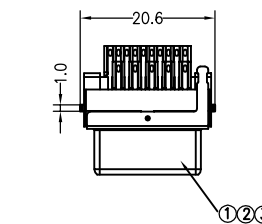
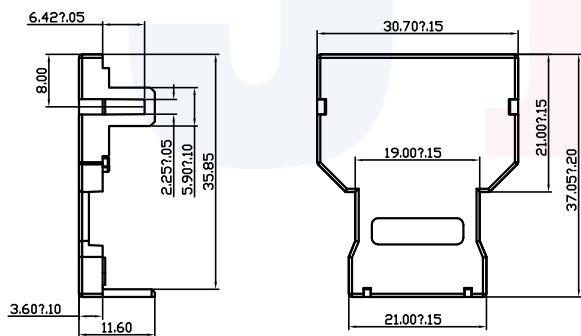
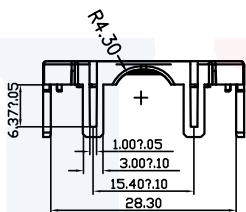
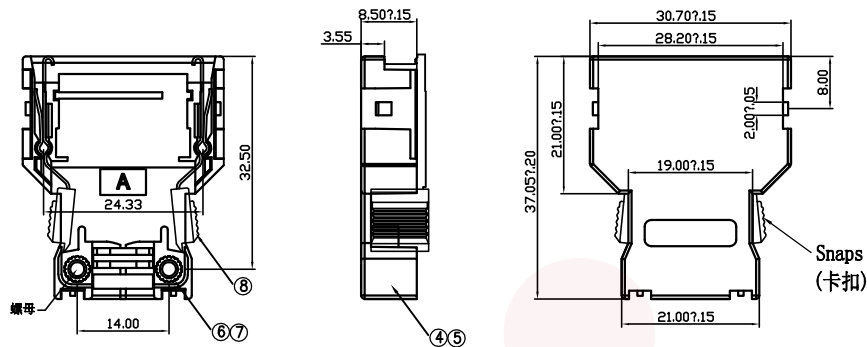


HSF RoHS



Ordering Information
6331-F 020 S S XX MNA 0X

No. of Pins
20P

Contact Plating
G4:3U" Gold
S2:3U" Gold /Tin

Pin No.	Specification	Material	Q'TY	UNIT
①	塑胶主本 (plastic body)	PA9T	PCS	1
②	端子 (terminal)	G5191-EH	PCS	20
③	铁壳 (iron shell)	SPCC	PCS	1
④	上外壳 (up outside shell)	PC	PCS	1
⑤	下外壳 (bottom outside shell)	PC	PCS	1
⑥	锁夹 (Lock)	S301	PCS	2
⑦	螺丝 (M2.5 screw)	STEEL	PCS	2
⑧	锁扣 (snaps)	SPCC	PCS	2

SPECIFICATIONS

Rated Current:1.0AMP
 Contact Resistance:35mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:200MΩ Min
 Operation Temperature:-40°C to +105°C
 Wire Accomodation:24,26,28,and 30AWG

Contact Material:Phosphor Bronze
 Shroud Material:Spcc
 Contact Area Plated:Sn Over Ni
 Solder Area Plated:Tin Plated
 Insulator Material:PA9T (UL94V-0)
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 5-10 seconds)

OPERATION		DRAW	YiYuSheng	20.11.04	SCALE	FIT
X.X	±0.30					
X.XX	±0.20	CHECK			UNIT	mm
X.XXX	±0.10				SIZE	A4
Angle	±3°	APPROVE			SHEET	1/1
DIM	TOL				PROJ.	◆

JILN® 深圳市锦凌电子有限公司
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REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A	2020.11.04	NEW DRAWING	

PART NO.	TITLE:
6331F015SSG4MNA01	SM-PCR 15P 母座 焊线式 第三代